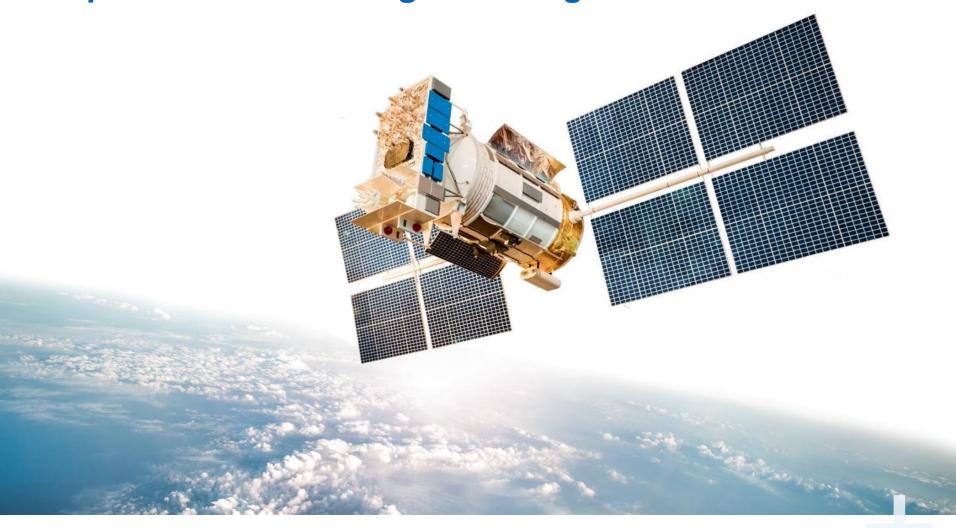
SPACE QUALIFIED CMOS 4 Mpixel Micro-camera for spacecraft monitoring and navigation





- Wissam MOUALLEM
- November 16th, 2018
- HERA Workshop, Berlin, Germany



3D PLUS Space Camera Sensors

More than 15 years experience in space camera sensors.



One year after its launch on 27 September 2003, ESA's SMART-1 spacecraft is in excellent health.

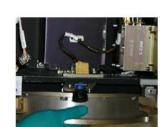
The first mission phase aiming at testing several innovative technologies has successfully been completed. In particular, it includes the 3D PLUS pcamera and a compact processing unit: the 3D



µDPU embedding a DSP21020 processor.

SMART-1 carries a miniaturised payload for cruise science experiments, telecommunication and spacecraft navigation which includes 3D PLUS high resolution µcamera.





PROBA 2, Earth Observation, ESA

CURIOSITY, Mars Mission, JPL - USA



2003 2004 2005 2006 2007 2008 2009 2010 2011 2012 2013 2014 2015 2016 2017 2018 2019

ROSETTA / PHILAE, Deep Space Mission, ESA



3D PLUS has developed µcamera electronic module on the main spacecraft of the mission.

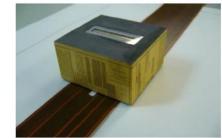
one of the most challenging missions ever attempted as, in particular, it will journey beyond the main asteroid belt and will be the first mission to ever

land on a comet. Rosetta will follow the comet for many

Launched in March 2004, Rosetta is

months as it heads towards the Sun. The main task is to study comets, which are considered the primitive building blocks of the Solar System. This will help us to understand if life on Earth began with the help of 'comet seeding'.





Charly4M, CNES Sentinel 1A, GMES, ESA



MARS 2020, Mars Mission, JPL - USA



Auriga, Sodern/OneWeb, USA









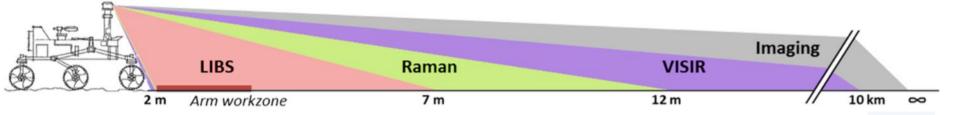
Context and Applications





- 2015: CNES partnership (French Space Agency) for the development of a **CMOS Microcamera.**
 - Mars2020 Rover (MSL)
- MSL SuperCam Instrument (LIBS, Raman) for geological analysis, requires a context imager.
- At the same time, 3D PLUS would offer this MicroCamera as a catalogue product.







Space Camera

Functional Description



FPGA - Flash based

User re-configurable. Latch-up free

Image processing: averaging, windowing, debayering...

Volatile & Non-volatile memories

NAND Flash 8Gb; up to 50 images storage

SDRAM 2x512Mb; up to 16 images/sec

Power Supply

Power consumption ~ 2W

Protections

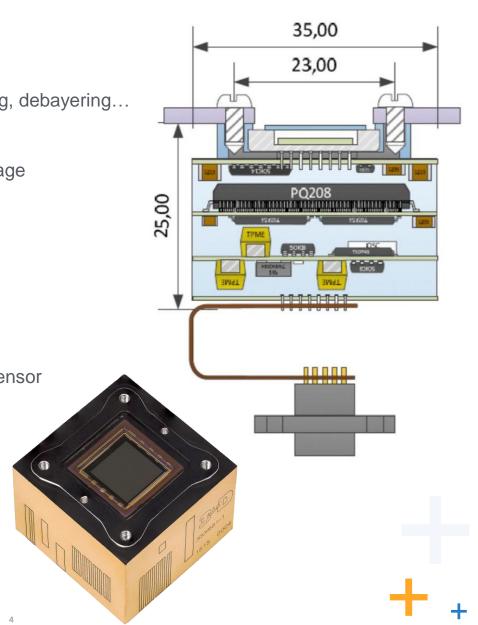
Current Limitation capability →

Anti-Latchup protection system for the sensor

Characteristics

Volume: 35 x 35 x 23 mm³

Weight: < 64g

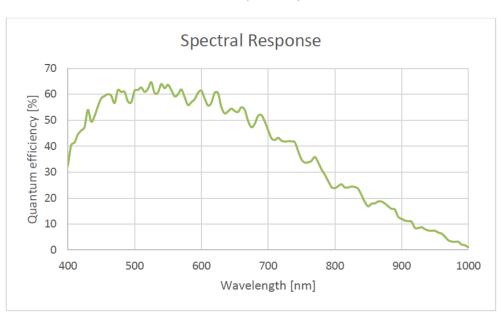


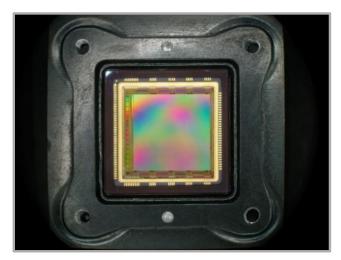
CMOS Sensor

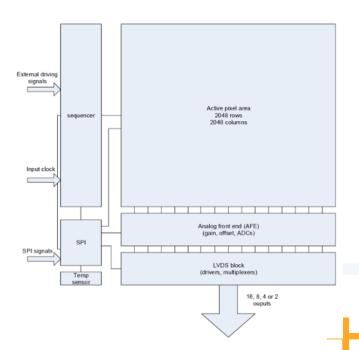
Key Features

_plus

- 4Mpx RGB/Monochrome 2048 x 2048 active pixels
- 5.5 µm pixel size
- 1" optical format
- High frame rate and digital output
- On-chip temperature sensor
- Microlenses included, optional BAYER filter
- 13 e- Dark Noise
- **125 e-/s** dark current (25°C)







Space Camera Heritage and Applications

Mutiple missions



Mission: Scientific

Name of satellite: EYE-

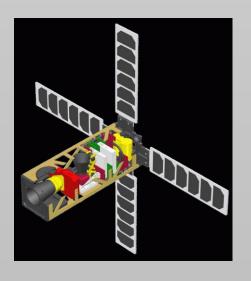
SAT

Customer: CNES

Application: Observation

of Zodiacal light of the

earth



Mission: Scientific Name of satellite: MARS2020 Rover

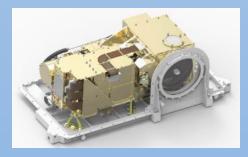
Customer: NASA

Application: SUPERCAM

instrument, chemical

analysis





Mission: Scientific

Name of satellite: LUNA

RESURS

Customer:

LEONARDO/ROSKOSMOS

Application: Monitoring of drilling on PROSPECT

instrument





Space Camera Heritage and Applications

Mutiple missions



Mission: Commercial

Name of satellite:

OneWeb Constellation

Customer:

SODERN/OneWeb

Application: 1800

startrackers for 900

satellites



Mission: Scientific

Name of satellite: PACE

Customer: SRON

Application: Aerosols

measurement, using a

spectro-polarimeter



Mission: Commercial

Name of satellite:

confidential

Customer: Confidential

Application: Docking and

Rendez-Vous sensor for

ISS

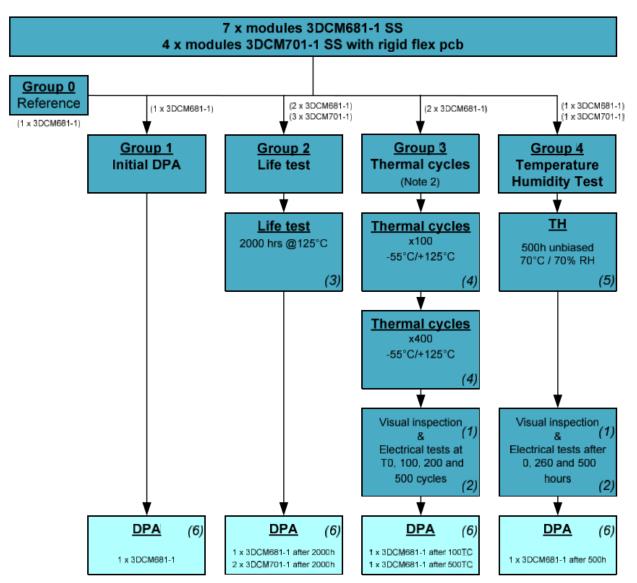




Camera qualification

Space models qualification





All tests succesfull



Space Camera conclusion

Key Features and Benefits



- 2048x2048 active pixels; 5.5µm-pitch
- Frame rate:
 - 7 fps (12-bit mode Full frame)
 - 16 fps (10 bit-mode Full frame)
 - Higher frame rate with windowing
- Integrated SDRAM & NAND Flash
- LVDS signals (10 outputs/ 2 inputs)
 - Spacewire, Ethernet, other available
- Radiation Hardened by Design
 - TID > 50Krad(Si)
 - SEL LET > 60MeV.cm²/mg
- -40°C to +70°C
- **62**q
- 35 x 35 x 23 mm



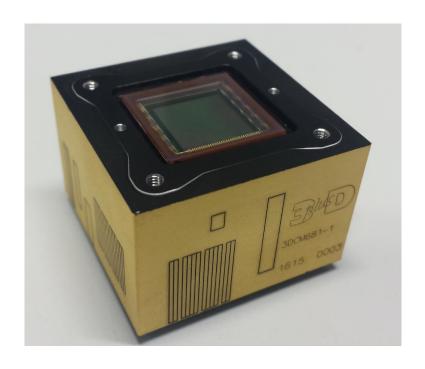
- Ruggedized design (**SEE Immune**)
- **Mechanical support** for the optics
 - **Versatile** (multiple applications)
 - All components included
 - High **storage** capacity
 - Technical **support**
 - HW + SW offer





Thanks For Your Attention





www.3d-plus.com

Today's Technology for Tomorrow's Electronics

3D PLUS

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